

11-30-2000

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office
Attorney Docket No. 150.0117010111/9/00
101533085

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

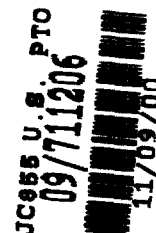
1. Name of conveying party(ies):

Cem Basceri
Gurtej SandhuAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ OtherExecution Date: October 27, 2000

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.Street Address: 8000 South Federal WayCity: Boise State: ID ZIP: 83707Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

9711206

If this document is being filed together with a new application, the execution date of the application is: October 27, 2000

A. Patent Application No(s).

B. Patent No(s).

Title: **METHODS FOR FORMING CONDUCTIVE STRUCTURES AND STRUCTURES REGARDING SAME**Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mark J. Gebhardt
Address: MUETING, RAASCH & GEBHARDT, P.A.
P.O. Box 581415
Minneapolis, MN 55458-14156. Total number of applications and patents involved: 17. Total fee (37 CFR §3.41): \$ 40.00☒ Enclosed
☐ Authorized to be charged to deposit account8. Please charge any additional fees or credit any overpayments to Deposit account number: 13-4895

DO NOT USE THIS SPACE

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is an original or a true copy of the original document.*Mark J. Gebhardt
Name of Person Signing
Signature9 Nov 2000
DateTotal number of pages including cover sheet, attachments, and document(s): 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks

Box Assignments

Washington, D.C. 20231

US 2000 (TUN) 0000024 09711206

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40.00 00

PATENT
REEL: 011274 FRAME: 0769

ASSIGNMENT

Whereas We, Cem Basceri and Gurtej Sandhu, with residences and citizenships as indicated below; have made an invention in

METHODS FOR FORMING CONDUCTIVE STRUCTURES AND STRUCTURES REGARDING SAME

Filed: Herewith

Serial No.: Unassigned

and executed an application for Letters Patent of the United States of America based thereon;

Now, therefore, for good and valuable consideration, receipt of which is acknowledged, we have individually and jointly agreed to assign and transfer and do hereby assign and transfer unto Micron Technology, Inc. ("Company"), a corporation of Boise, Idaho, having its principal office at 8000 South Federal Way, Boise, Idaho 83707, its successors and assigns, the entire right, title, and interest in and to said invention and application, and in and to any division or continuation (in whole or in part) of said application, and in and to any and all improvements in said invention made by us or any of us or made jointly with others (provided any such improvement is made during, or within one year after the termination of, the employment by the Company of whichever of us, solely or jointly with one or more others, has made the same), and in and to any and all Letters Patent, reexaminations, reissues, or extensions thereof, of the United States of America and countries foreign thereto (including the right to apply for Letters Patent, Utility Models, or Inventors' Certificates in foreign countries in its own name and to claim any priority rights for such foreign applications to which such applications are entitled under international conventions, treaties, or otherwise), which have been or may be granted thereon or on any continued prosecution application, divisional, continuation (in whole or in part), renewal, reexamination, reissue, or other or further application based in whole or in part upon said invention or improvements thereon, to be held and enjoyed as fully and exclusively as they would have been by us or any of us had this assignment and transfer not been made;

We do further agree for ourselves and for our heirs, executors, and administrators, to execute and deliver without further consideration any further applications, assignments, and documents, and to perform such other acts as we lawfully may, that may be deemed necessary by the Company, its successors, assigns, and nominees, fully to secure its right, title, and interest as aforesaid and to obtain or maintain Letters Patent, Utility Models, or Inventors' Certificates in any and all countries;

And we do hereby authorize and request the Commissioner of Patents to issue any and all Letters Patent which may be granted upon any of said applications, to Micron Technology, Inc. as the assignee of the entire right, title, and interest therein.

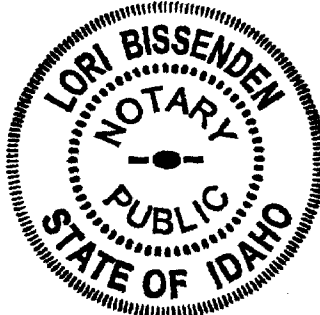
In witness whereof, we have hereunto signed our names on the days and years set forth below.

Cem Basceri 10/27/00
 Name: **Cem Basceri** Date
 Address: 3236 Gekeler Lane, Apt. B-204 314 E. Java St.
Boise, ID 83706 OS.
 Citizenship: Turkey

STATE OF Idaho)
) ss.
 COUNTY OF Ada)

On this 27th day of October 2000 before me personally appeared Cem Basceri
 to me known to be the person described in and who executed the foregoing instrument, and he/she executed the same
 for the uses and purposes therein set forth.

Lori Bissenden
 Notary Public



Serial No.: Unassigned

Filed: Herewith

For: METHODS FOR FORMING CONDUCTIVE STRUCTURES AND STRUCTURES REGARDING SAMEGurtej Sandhu10/27/00Name: **Gurtej Sandhu**

Date

Address: 2964 East Parkriver DriveBoise, ID 83706

Citizenship: United States of America

STATE OF Idaho)COUNTY OF Ada) ss.

On this 27th day of October 2000 before me personally appeared Gurtej S. Sandhu to me known to be the person described in and who executed the foregoing instrument, and he/she executed the same for the uses and purposes therein set forth.

Lori Bissenden
Notary Public